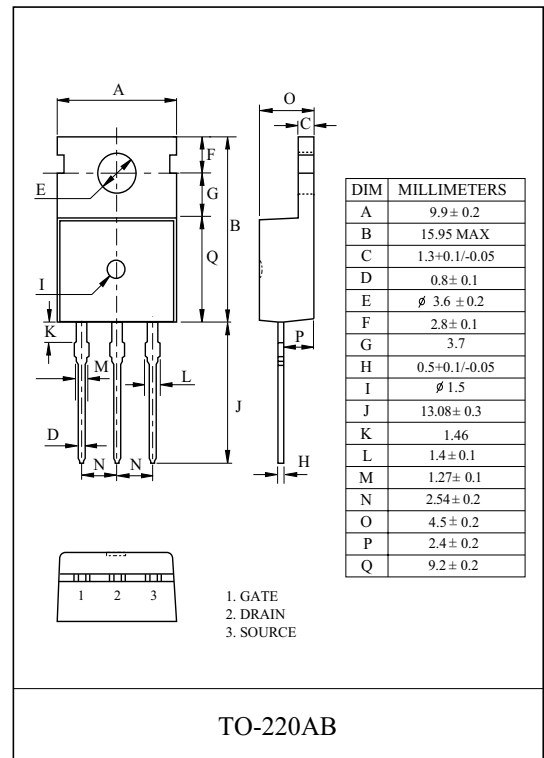


## General Description

This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for active power factor correction, electronic lamp ballasts based on half bridge topology and switching mode power supplies.

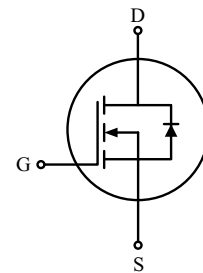
## FEATURES

- $V_{DSS}=75V$ ,  $I_D=75A$
- Drain-Source ON Resistance :  
 $R_{DS(ON)}=0.017 \Omega @V_{GS} = 10V$
- $Q_g(\text{typ.}) = 85nC$
- Improved dv/dt capacity, high Ruggedness
- Maximum Junction Temperature Range (175 °C)



## MAXIMUM RATING (Tc=25 °C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Drain-Source Voltage	$V_{DSS}$	75	V
Gate-Source Voltage	$V_{GSS}$	±20	V
Drain Current	@T <sub>c</sub> =25 °C	75	A
	@T <sub>c</sub> =100 °C	52.5	
	Pulsed (Note1)	$I_{DP}$	
Single Pulsed Avalanche Energy (Note 2)	$E_{AS}$	1350	mJ
Repetitive Avalanche Energy (Note 1)	$E_{AR}$	19	mJ
Peak Diode Recovery dv/dt (Note 3)	dv/dt	7.0	V/ns
Drain Power Dissipation	T <sub>c</sub> =25 °C	190	W
	Derate above 25 °C	1.27	W/ °C
Maximum Junction Temperature	T <sub>j</sub>	175	°C
Storage Temperature Range	T <sub>stg</sub>	-55 ~ 175	°C
<b>Thermal Characteristics</b>			
Thermal Resistance, Junction-to-Case	R <sub>thJC</sub>	0.79	°C/W
Thermal Resistance, Case-to-Sink	R <sub>thCS</sub>	0.5	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62.5	°C/W



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## ELECTRICAL CHARACTERISTICS (Tc=25 °C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	75	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_j$	$I_D=250\mu A$ , Referenced to 25 °C	-	0.08	-	V/°C
Drain Cut-off Current	$I_{DSS}$	$V_{DS}=75V, V_{GS}=0V$ ,	-	-	10	$\mu A$
Gate Threshold Voltage	$V_{th}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	-	4.0	V
Gate Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=37.5A$	-	0.013	0.017	$\Omega$
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=60V, I_D=75A$ $V_{GS}=10V$ (Note4,5)	-	85	110	nC
Gate-Source Charge	$Q_{gs}$		-	15	-	
Gate-Drain Charge	$Q_{gd}$		-	40	-	
Turn-on Delay time	$t_{d(on)}$	$V_{DD}=37.5V$ $I_D=75A$ $R_G=25\Omega$ (Note4,5)	-	25	60	ns
Turn-on Rise time	$t_r$		-	300	700	
Turn-off Delay time	$t_{d(off)}$		-	150	310	
Turn-off Fall time	$t_f$		-	180	370	
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	3000	-	pF
Reverse Transfer Capacitance	$C_{riss}$		-	250	-	
Output Capacitance	$C_{oss}$		-	1100	-	
<b>Source-Drain Diode Ratings</b>						
Continuous Source Current	$I_S$	$V_{GS}<V_{th}$	-	-	75	A
Pulsed Source Current	$I_{SP}$		-	-	300	
Diode Forward Voltage	$V_{SD}$	$I_S=75A, V_{GS}=0V$	-	-	1.5	V
Reverse Recovery Time	$t_{rr}$	$I_S=75A, V_{GS}=0V$ , $dI_S/dt=100A/\mu s$	-	90	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	250	-	$\mu C$

Note 1) Repetivity rating : Pulse width limited by junction temperature.

Note 2)  $L=0.32mH, I_S=75A, V_{DD}=25V, R_G=25\Omega$ , Starting  $T_j=25\text{ }^\circ\text{C}$ .

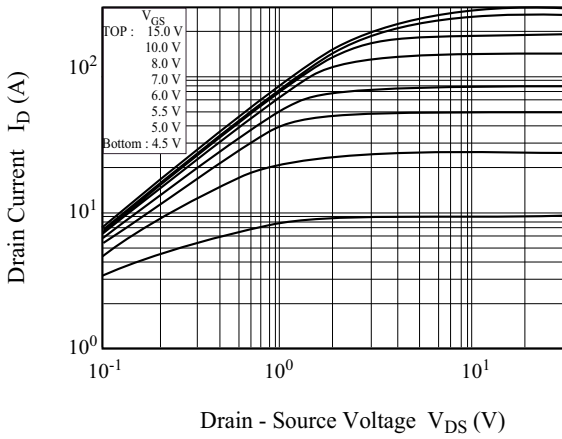
Note 3)  $I_S \leq 75A, dI/dt \leq 300A/\mu s, V_{DD} \leq BV_{DSS}$ , Starting  $T_j=25\text{ }^\circ\text{C}$ .

Note 4) Pulse Test : Pulse width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .

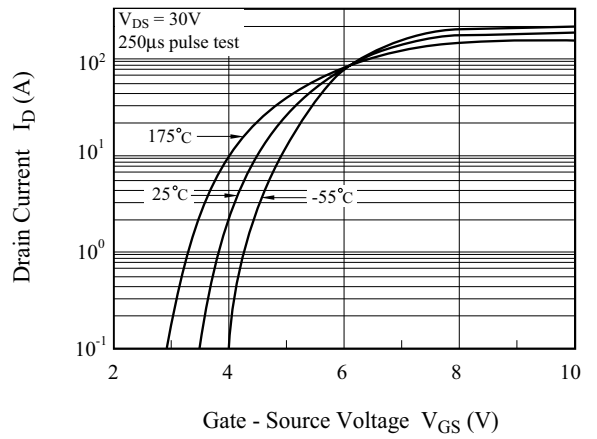
Note 5) Essentially independent of operating temperature.

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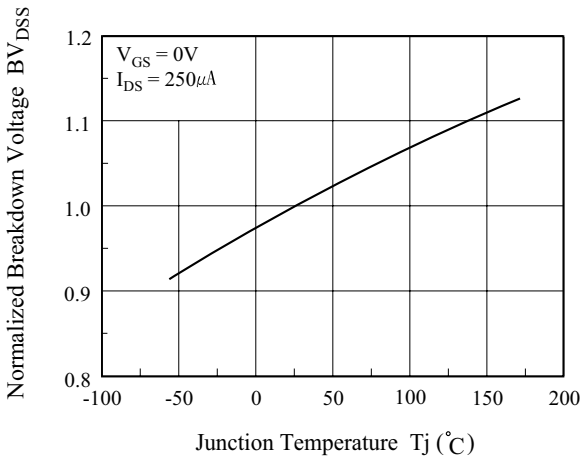
$I_D - V_{DS}$



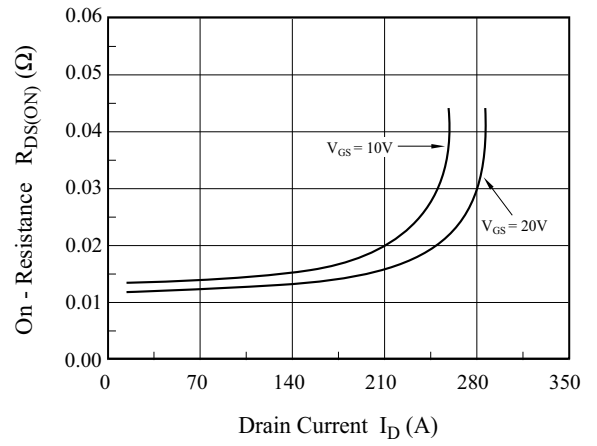
$I_D - V_{GS}$



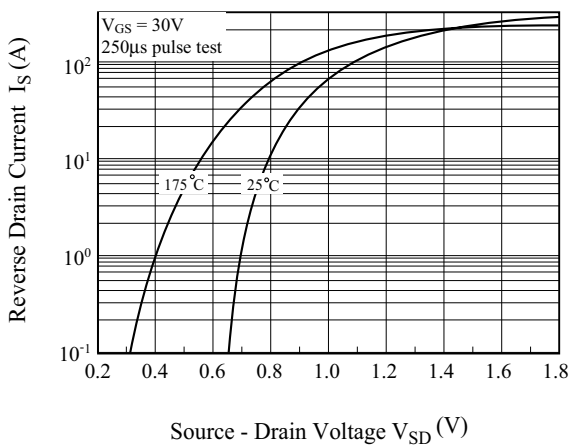
$BV_{DSS} - T_j$



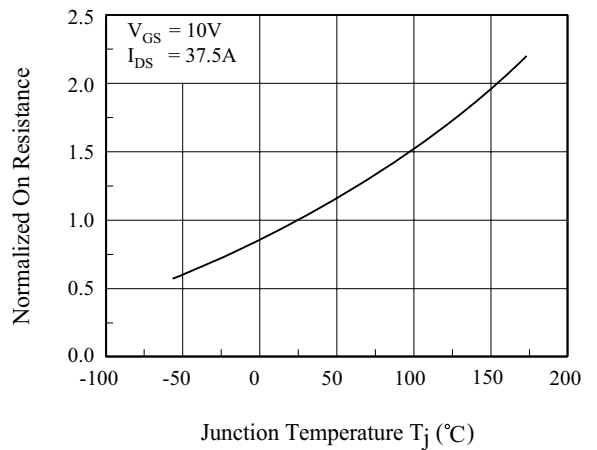
$R_{DS(ON)} - I_D$



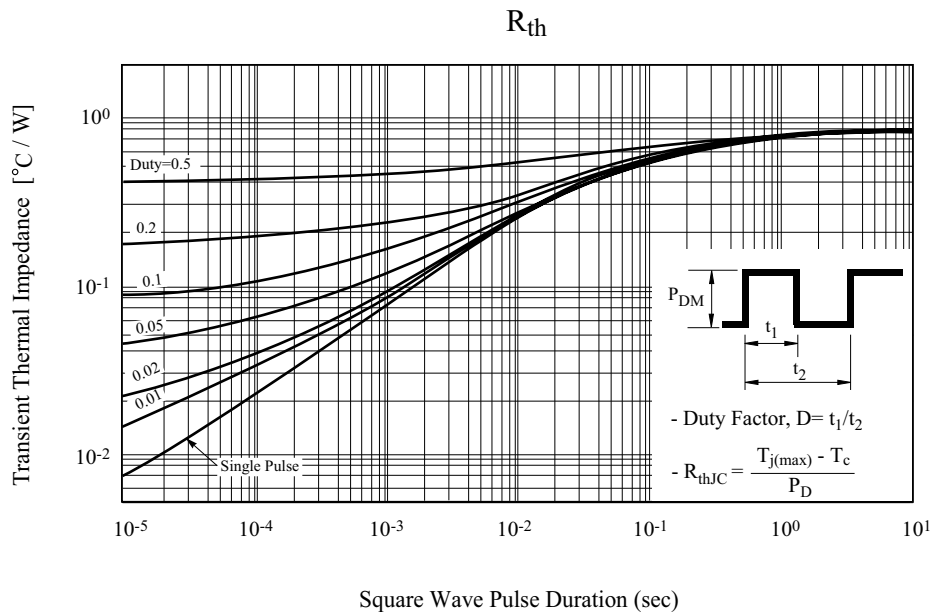
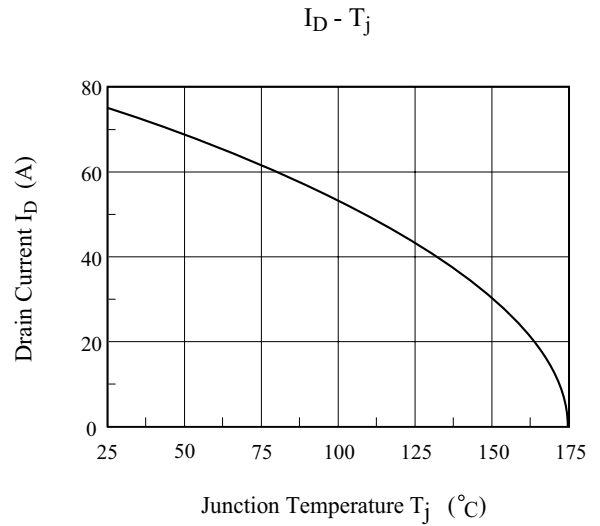
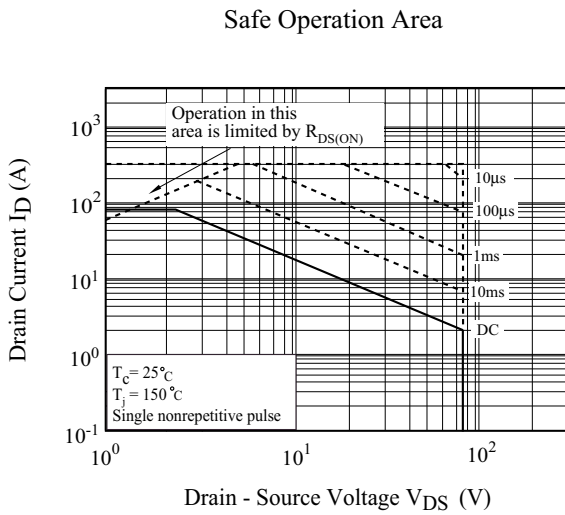
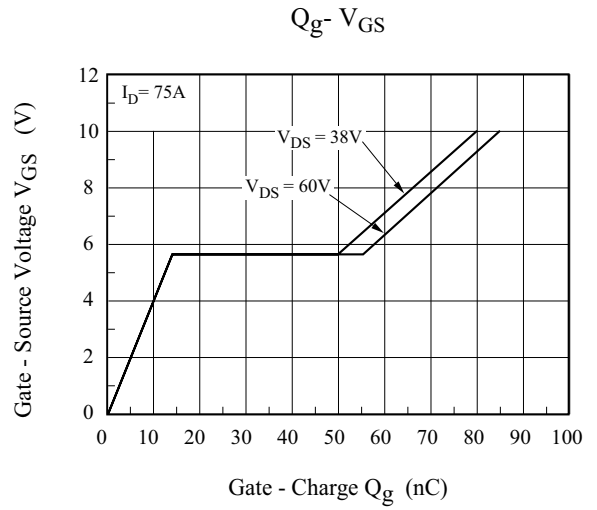
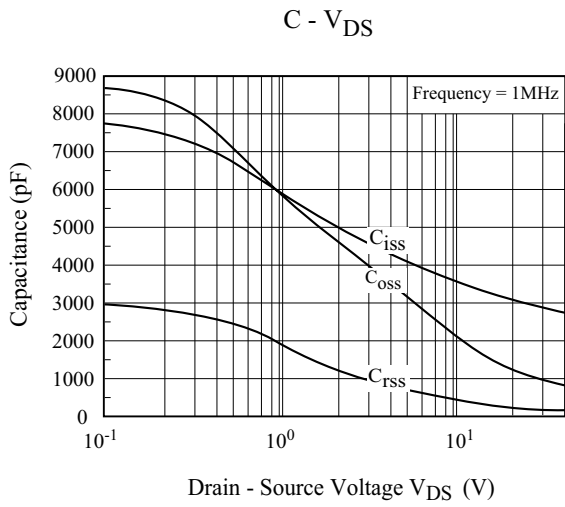
$I_S - V_{SD}$



$R_{DS(ON)} - T_j$

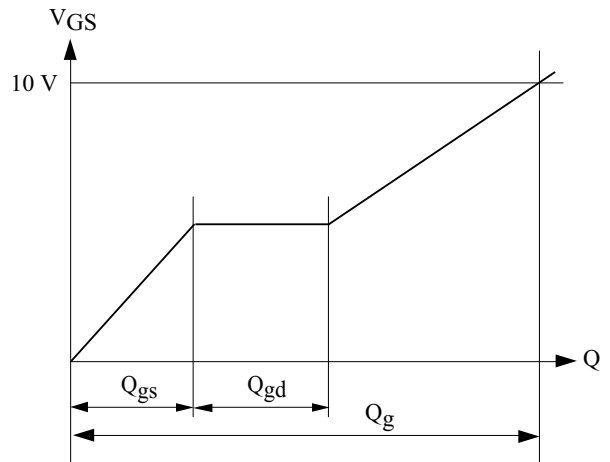
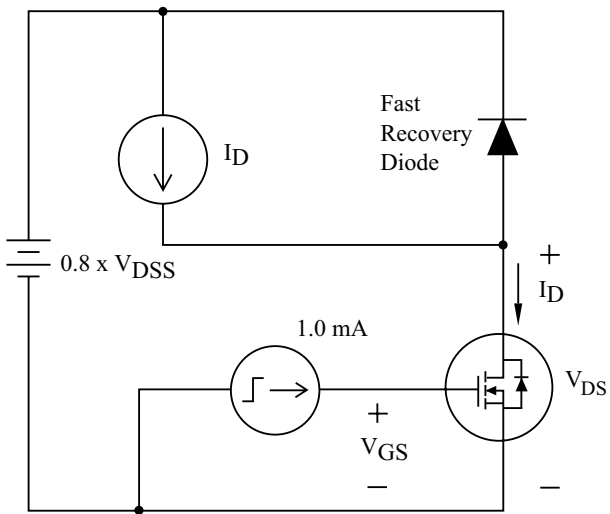


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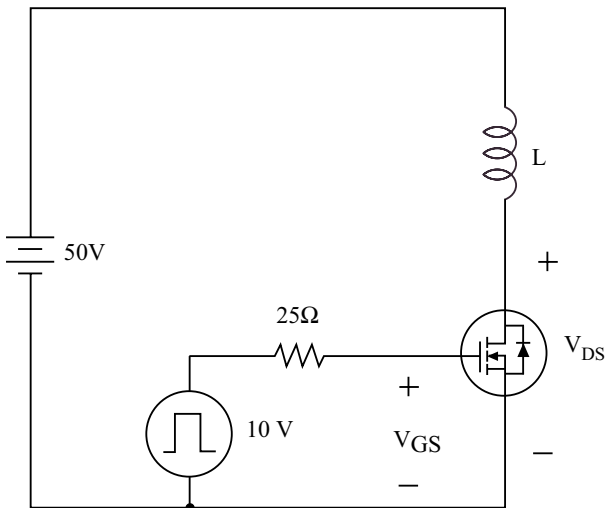


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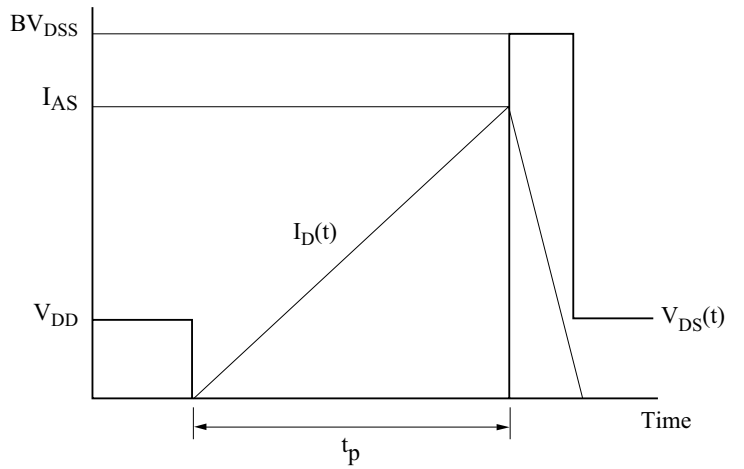
## - Gate Charge



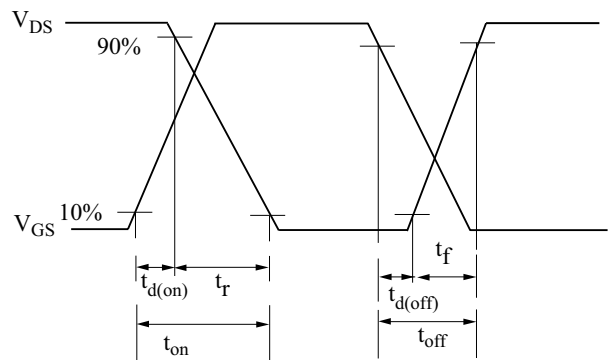
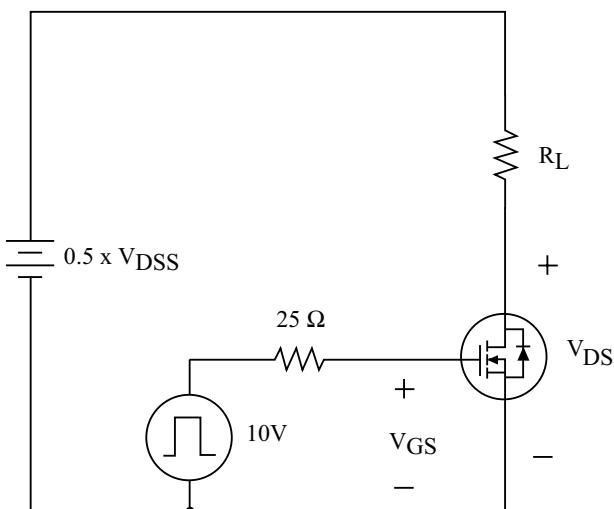
## - Single Pulsed Avalanche Energy



$$E_{AS} = \frac{1}{2} L I_{AS}^2 \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$



## - Resistive Load Switching



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- Source - Drain Diode Reverse Recovery and  $dv/dt$

